


ETU-LINK

Optical Communication System

PON Series

GPON

EGP52X-3SCDN20

XGS-PON&XGPON OLT N1/N2/E1 SFP+

Optical Transceiver

- Single fiber bi-directional data links TX 9.95Gbps, Burst Mode RX 9.95G/2.488Gbps application
- Compliant with ITU-T XGS-PON G.9807.1
- Support ITU-T G.987.2 XGSPON OLT N1/N2/E1 application
- 0 to 70°C operating case temperature
- 3.3V power supply
- SFP+ package with SC Receptacle connector
- Hot-pluggable capability
- High power 1577nm EML LD
- High sensitivity 1270nm APD
- Support XGS-PON or XG-PON 20km application with SMF
- RX_SD indication
- Low EMI and excellent ESD protection
- Digital diagnostic monitor interface
- RoHS6 compliance



Applications

- XGS -PON OLT N1/N2/E1

Standard

- Complies with SFF-8472
- Complies with ITU G.987.2
- Complies with ITU G.9807.1
- Complies with FCC 47 CFR Part 15, Class B
- Complies with FDA 21 CFR 1040.10 and 1040.11

Performance Specifications

Absolute Maximum Ratings						
Parameter	Symbol	Min.	Max.	Unit	Note	
Storage Ambient Temperature	T _{STG}	-40	85	°C		
Operating Case Temperature	T _c	0	70	°C		
Operating Humidity	OH	5	85	%		
VCC3 Power Supply Voltage	V _{CC}	3.135	3.465	V		
Recommended Operating Conditions						
Parameter	Symbol	Min.	Typical	Max.	Unit	Note
Operating Case Temperature	T _c	0		70	°C	
Power Supply Voltage	V _{CC}	3.13	3.3	3.47	V	
Power Supply Consumption	P			2.4	W	
TX Data Rate			9.95		Gbps	
RX Data Rate			9.95		Gbps	
			2.488		Gbps	

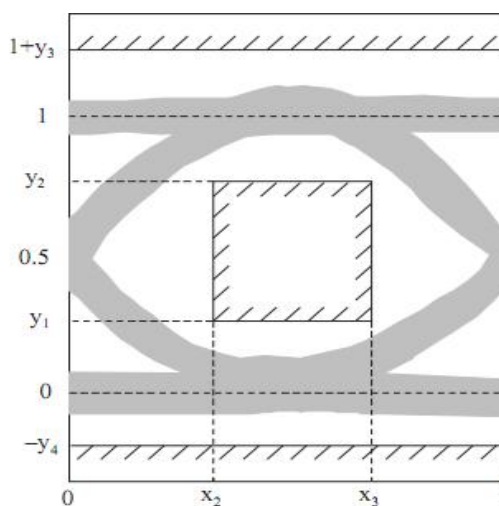
XGS-PON Transmitter Optical Characteristics						
Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Optical Center Wavelength	λ_C	1575		1580	nm	
Optical Spectrum Width (-20dB)	$\Delta\lambda$	-	-	1	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Transmitter and Dispersion Penalty	TDP			1	dB	Transmit on 20km SMF
Average Launch Optical Power (N1)	AOP	+2		+5	dBm	Launched into SMF

Average Launch Optical Power (N2)	AOP	+4		+7	dBm	Launched into SMF
Average Launch Optical Power (E1)	AOP	+6		+9	dBm	Launched into SMF
Power-OFF Transmitter Optical Power				-39	dBm	Launched into SMF
Extinction Ratio	ER	8.2			dB	PRBS2 ³¹ -1 @9.95Gbps
Optical Waveform Diagram	Compliant with ITU G.9807.1					Figure 1, Mask Margin>5%

XGS-PON Transmitter Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Data Input Differential Swing		120		820	mV	CML input, DC coupled
Input Differential Impedance		90	100	110	Ω	
TX Disable	Disable	2		VCC +0.3	V	
	Enable	-0.3		0.8	V	
Transmitter Disable Time	Toff			100	μ S	
Transmitter Enable Time	Ton			2	mS	

Transmitter Eye Mask Definitions and Test Procedure



X3-X2	Y1	Y2	Y3	Y4	Unit
0.2	0.25	0.75	0.25	0.25	UI

Fig.1 XGPON Transmitter Eye Mask Definition

XGS-PON Receiver Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Operating Wavelength		1260		1280	nm	
Sensitivity (N1)	SEN			-26	dBm	PRBS2 ³¹ -1@9.95Gbps BER ≤1×10 ⁻³
Sensitivity (N2)	SEN			-28	dBm	
Sensitivity (E1)	SEN			-30	dBm	
Saturation Optical Power (N1)	SAT	-5			dBm	
Saturation Optical Power (N2)	SAT	-7			dBm	
Saturation Optical Power (E1)	SAT	-9			dBm	
Max Input power		-3			dBm	
SD Assert Level				-27	dBm	
SD De-Assert Level		-45			dBm	
Hysteresis		0.5		6	dB	

XGPON Receiver Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Operating Wavelength		1260		1280	nm	
Sensitivity (N1)	SEN			-27.5	dBm	PRBS 2 ²³ -1@2.488Gbps BER ≤1×10 ⁻⁴
Sensitivity (N2)	SEN			-29.5	dBm	
Sensitivity (E1)	SEN			-31.5	dBm	
Saturation Optical Power (N1)	SAT	-7			dBm	
Saturation Optical Power (N2)	SAT	-9			dBm	
Saturation Optical Power (E1)	SAT	-12			dBm	
Max Input power		-3			dBm	
SD Assert Level				-29	dBm	
SD De-Assert Level		-45			dBm	
Hysteresis		0.5		6	dB	

XGS/XGPON Receiver Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Receiver Threshold	T_{SETTLI}			400	ns	Figure 3
Settling Time	T_{SETTLI}					
Data Output Differential Swing		400		1000	mV	CML output, AC coupled
Input Differential Impedance	Z_{in}	90	100	110	Ω	
SD Assert Level Time				512	ns	
SD De-Assert Level Time				2048	ns	
SD Voltage - Low		-0.3		0.4	V	
SD Voltage - High		2.4		VCC+ 0.3	V	
RSSI Trigger-Low		-0.3		0.8	V	
RSSI Trigger-High		2.0		VCC+ 0.3	V	
CID		72			Bit	

Timing Parameter Definitions in Burst Mode Sequence

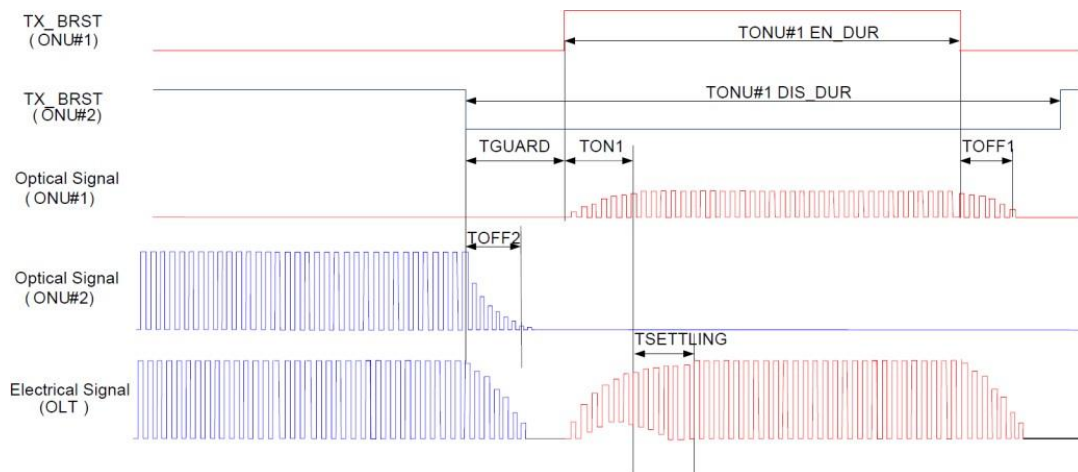


Fig. 2 Timing Parameter Definitions in Burst Mode Sequence

RSSI Timing Sequence						
Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Optical Signal During Time	T_{opt}	1500			ns	
RSSI Trigger width	TW	450	500	550	ns	
RSSI Trigger Delay	TD	250	300	350	ns	
I ² C Access Prohibited Time	TS			500	μ s	
I ² C Bus Frequency			100		KHz	

Digital RSSI Sample/Hold Timing Specification

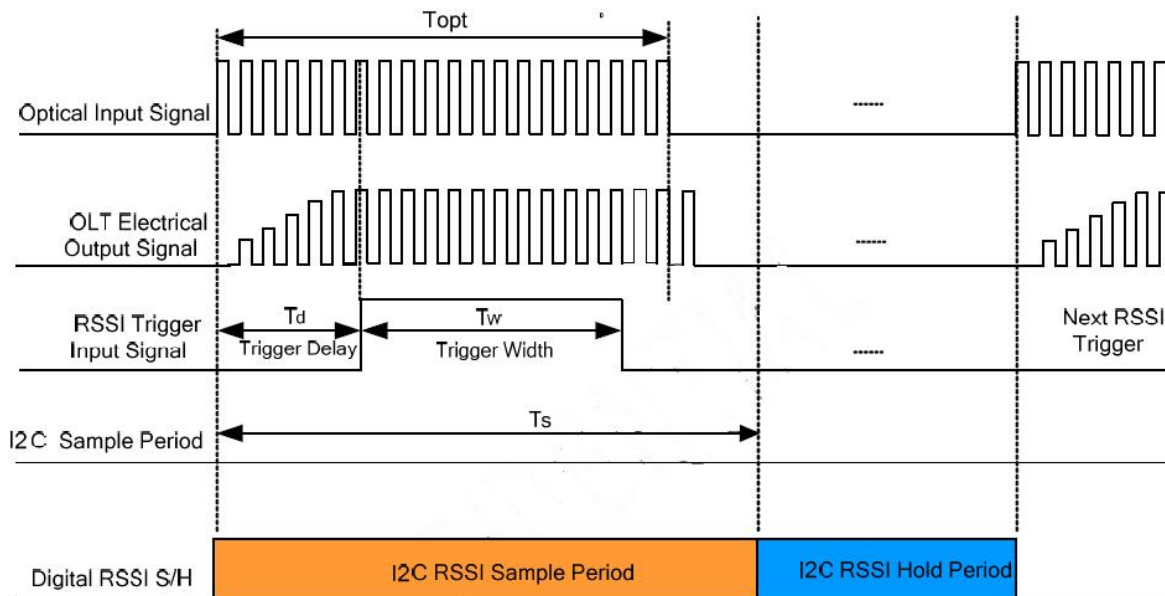


Fig. 3 Timing Parameter Definitions in RSSI Trigger

Pin Out Drawing

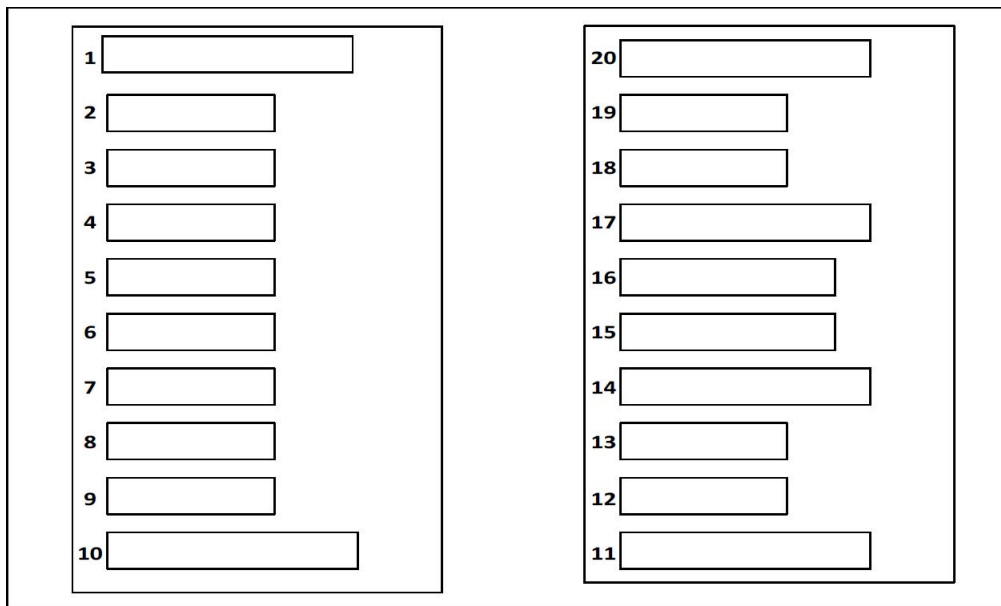


Fig.4 Pin Out Drawing

Pin	Name	Description	Notes
1	GND	GND.	
2	TX_Fault	TX fault out	
3	TX_Disable	TX disable in	
4	SDA	I2C Data in/out	
5	SCL	I2C Clock in	
6	MOD_ABS	Module absent	
7	RX_Reset	No connect	
8	RX_SD	Signal detect out	
9	RSSI_Trigger	RSSI trigger in	
10	GND	GND.	
11	GND	GND.	
12	XGS_RD-	XGSPON data out, CML	AC coupling
13	XGS_RD+	XGSPON data out, CML	AC coupling
14	GND	GND.	
15	VCCR	Module power	
16	VCCT	Module power	
17	GND	GND.	
18	XGS_TD+	XGSPON data in, CML	
19	XGS_TD-	XGSPON data in, CML	
20	GND	GND.	

Note: "1~20" PIN comply with SFF 8431.

EEPROM Information

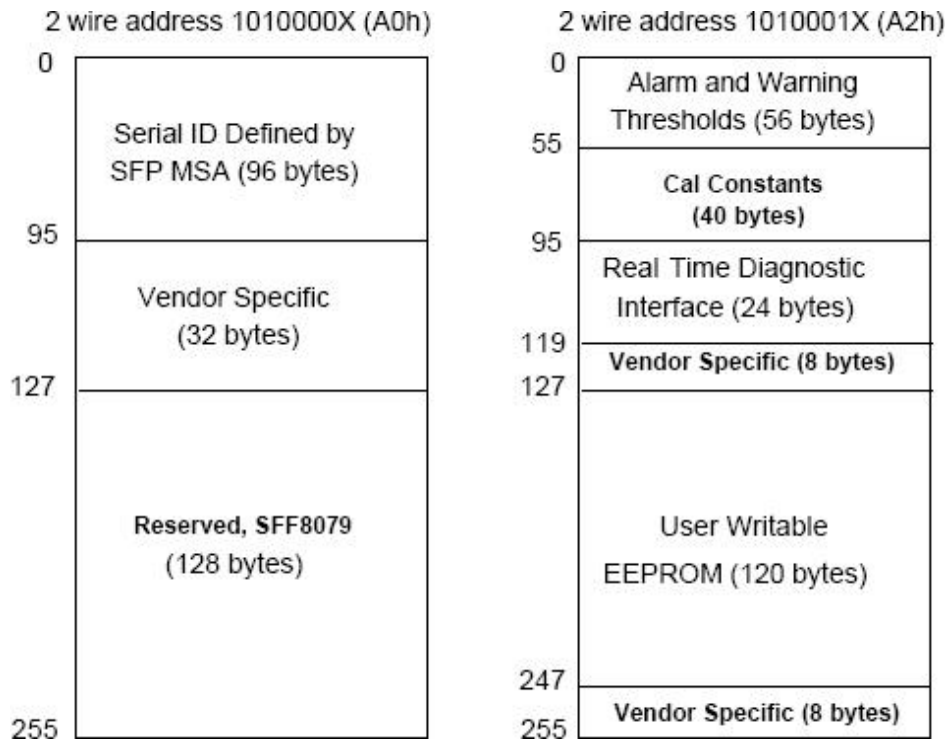
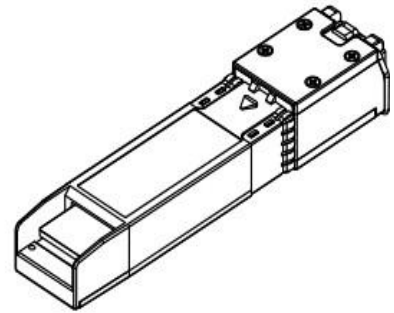
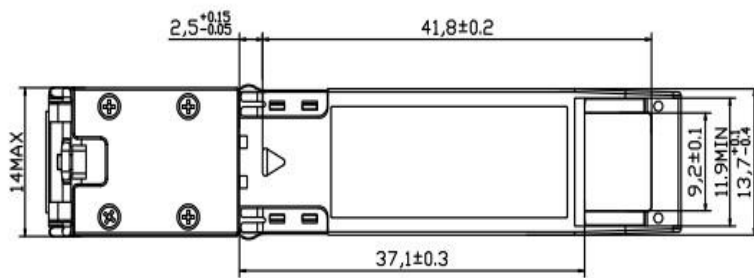
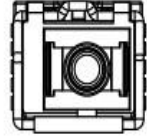
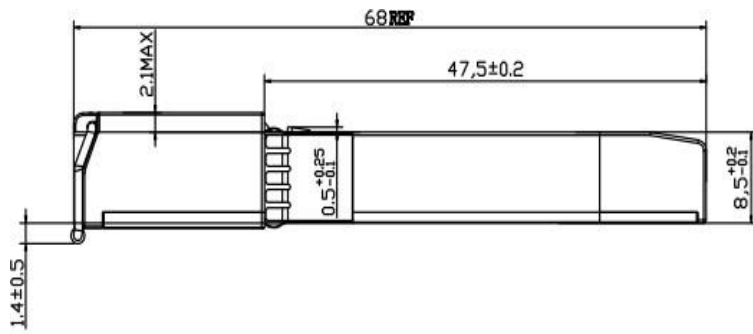


Fig. 5 EEPROM Memory Map Specific Data Field Descriptions

Digital Diagnostic Monitoring Interface				
Parameter	Range	Accuracy	Calibration	Notes
Temperature	0 to 70°C	±3°C	Internal	LSB: 1/256C
Voltage	2.97 to 3.63V	±5%	Internal	LSB: 0.1mV
Bias Current	0 to 262mA	±10%	Internal	LSB: 4uA
TX Power	1 to 6dBm	±3dB	Internal	LSB: 0.2uW
RX Power Monitor	-29 to -5dBm	±3dB	Internal	LSB: 0.1uW

Package Dimensions



Compatibility Test

In order to ensure the product compatibility, our products will be tested on the switch before shipment. Our modules can be compatible with many mainstream brand switches, such as Cisco, Juniper, Extreme, Brocade, IBM, H3C, HP, Huawei, D-Link, Mikrotik, ZTE, TP-Link...

Our test equipment: VOLKTEK MEN-4110, HP 2530-8G, CRS226-24G-25+RM, Catalyst 2960G Series, Catalyst 3850 XS 10G SFP+, Catalyst 3750-E Series, HUAWEI S5700Series, H3C S3100V2 Series, Juniper-EX4200, etc.



Cisco Catalyst 3850



HUAWEI S5700



H3C S3100V2



HP J9264AR



Juniper EX 4200



Alcatel 6850E-U24X



Mikrotik CR5226-24G-25+RM



Cisco Catalyst 2960G



Volktek MEN-4110

Product Production Process

Quality Assurance

Continuous introduction of new equipment, produced by strict standards, strict quality inspection, to guarantee the high quality standard of each product.



**Standardized
Production Line**



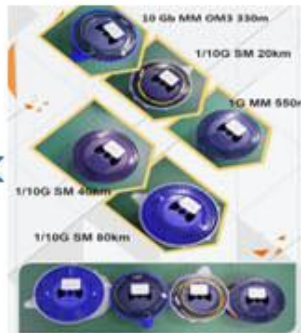
**Professional
Welding**



Assembling



Aging Testing



Distance Testing



Cleaning end face



Product Initial Test



Switch Testing



Product Final Test

Packaging

ETU-Link provides two kinds of packaging, 10pcs/Tray and individual package.



Company: ETU-Link Technology Co., LTD

Address: Right side of 3rd floor, No. 102 building, Longguan expressway, Dalang street,
Longhua District, Shenzhen city, Guangdong Province, China 518109

Tel: +86-755 2328 4603

Addresses and phone number also have been listed at www.etulinktechnology.com.

Please e-mail us at sales@etulinktechnology.com or call us for assistance.